ROBERT D. & DOROTHY W. TALTY
ENDOWED SCHOLARSHIP

In 2012, the Robert and Dorothy Family Trust established an endowment to provide funds for scholarships for CSU students majoring in engineering, physics, chemistry, biology and computer sciences.

Robert D. Talty graduated from the University of Kansas and went on to earn his Ph.D. in chemical engineering from the University of Delaware and his MBA from Southern Illinois University. He worked at T-Pack, the Department of Agriculture, and Heat Transfer Research, Inc. as president, helping to establish its global presence while fostering international marketing efforts and long-range strategic planning.

- One (1) $7,000 scholarship will be awarded for the 2023-2024 academic year.
- Each campus may nominate two students.

Applicants must:

- Be in good academic standing.
- Be currently enrolled as a full-time equivalent undergraduate or graduate student majoring in engineering, physics, chemistry, biology or computer sciences at a CSU campus.
- Remain a CSU full-time equivalent student during the academic year.

Applications are available through the campus Financial Aid Office.

The Financial Aid Office will review applications to ensure that they meet all stated requirements. The campus may submit two (2) applicants for consideration to the CSU Foundation to make the final selection. Completed applications submitted by the campus Financial Aid Office to the CSU Foundation must include the following:

Personal Statement (300 word count for each):

1. What experience has impacted your personal growth?
2. Tell us about a time you failed. What did you learn from that experience?
3. Why are you pursuing your major? How does it relate to your career aspirations?
4. Provide an example of service beyond the classroom (i.e., have you taken on significant family obligations, helped others in a specific way, been involved in political action, worked/volunteered/interned at a particular organization, etc.). Why is this example significant to you?

Contact the Financial Aid Department for the Spring Application Deadline.